## DATA SHEET



# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1731

## SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

#### DESCRIPTION

The  $\mu$ PA1731 is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

#### FEATURES

Low on-resistance

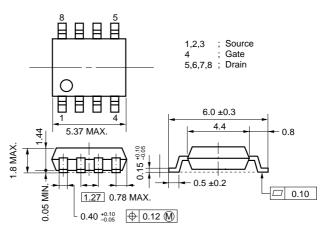
 $R_{\text{DS(on)1}}$  = 10.3 m $\Omega$  TYP. (Vgs = -10 V, ID = -5.0 A)

- $R_{\text{DS(on)2}}$  = 14.6 m $\Omega$  TYP. (Vgs = -4.5 V, ID = -5.0 A)
- $R_{DS(on)3} = 16.5 \text{ m}\Omega \text{ TYP.}$  (VGs = -4.0 V, ID = -5.0 A)
- Low Ciss : Ciss =2600 pF TYP.
  - Built-in G-S protection diode
  - Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

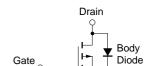
PART NUMBER	PACKAGE
μΡΑ1731G	Power SOP8

#### PACKAGE DRAWING (Unit : mm)



#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, All terminals are connected.)

#### Drain to Source Voltage (Vgs = 0 V) -30 V Voss Gate to Source Voltage (VDS = 0 V) **∓ 20** VGSS V Drain Current (DC) ID(DC) $\mp$ 10 A Drain Current (pulse) Note1 **∓ 40** D(pulse) Α Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$ Pτ 2.0 W **Channel Temperature** °C Tch 150 Storage Temperature °C Tstg -55 to + 150



**EQUIVALENT CIRCUIT** 

Gate Protection Diode Source

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %

2. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

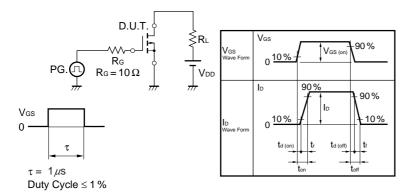
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## NEC

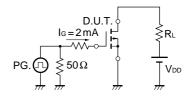
*	LECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C, All terminals are connected.)
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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = −10 V, Id = −5.0 A		10.3	13.0	mΩ
	RDS(on)2	$V_{GS} = -4.5 \text{ V}, \text{ ID} = -5.0 \text{ A}$		14.6	19.5	mΩ
	RDS(on)3	Vgs = -4.0 V, Id = -5.0 A		16.5	22.0	mΩ
Gate to Source Cut-off Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ ID} = -1 \text{ mA}$	-1.0	-1.6	-2.5	V
Forward Transfer Admittance	y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, \text{ Id} = -5.0 \text{ A}$	8.0	18.0		S
Drain Leakage Current	IDSS	Vds = 30 V, Vgs = 0 V			-1	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			<b>∓ 10</b>	μA
Input Capacitance	Ciss	$V_{DS} = -10 V$		2600		pF
Output Capacitance	Coss	Vgs = 0 V		810		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		350		pF
Turn-on Delay Time	td(on)	ID = -5.0 A		32		ns
Rise Time	tr	$V_{GS(on)} = -10 V$		185		ns
Turn-off Delay Time	td(off)	Vdd = -15 V		155		ns
Fall Time	tr	R <sub>G</sub> = 10 Ω		110		ns
Total Gate Charge	Q <sub>G</sub>	ID = -10 A		46		nC
Gate to Source Charge	Q <sub>GS</sub>	$V_{DD} = -24 V$		6.5		nC
Gate to Drain Charge	Qgd	Vgs = -10 V		12		nC
Body Diode Forward Voltage	VF(S-D)	IF = 10 A, VGs = 0 V		0.80		V
Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		50		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ μs		46		nC

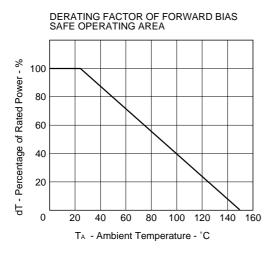
### **TEST CIRCUIT 1 SWITCHING TIME**

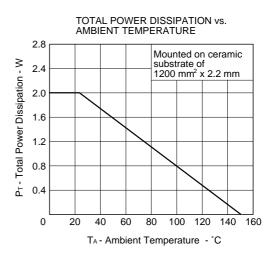


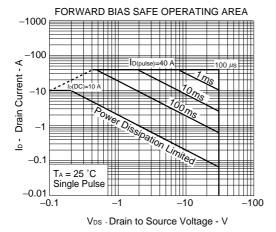
### TEST CIRCUIT 2 GATE CHARGE

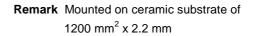


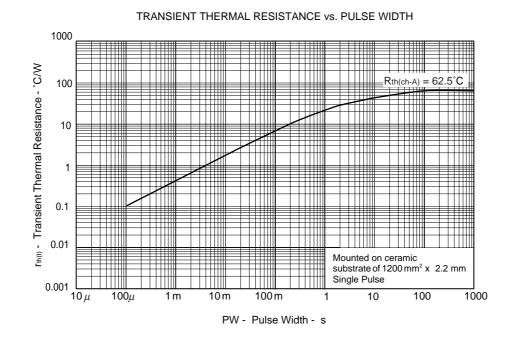
**★** TYPICAL CHARACTERISTICS ( $T_A = 25 \ ^{\circ}C$ )



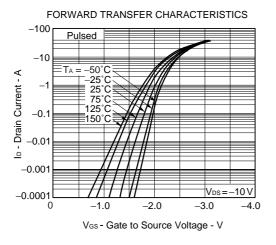




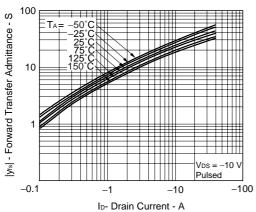


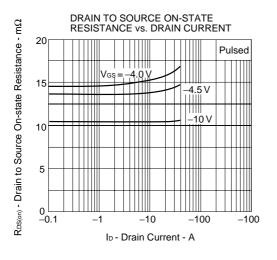


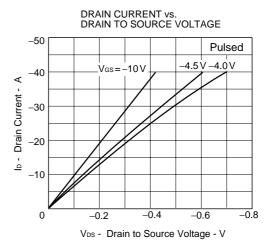
Data Sheet G14285EJ1V0DS00



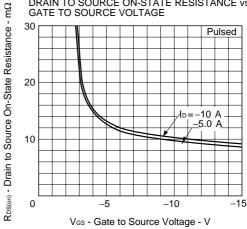




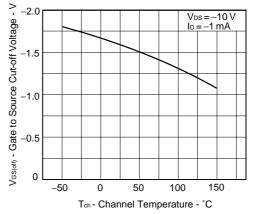




DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

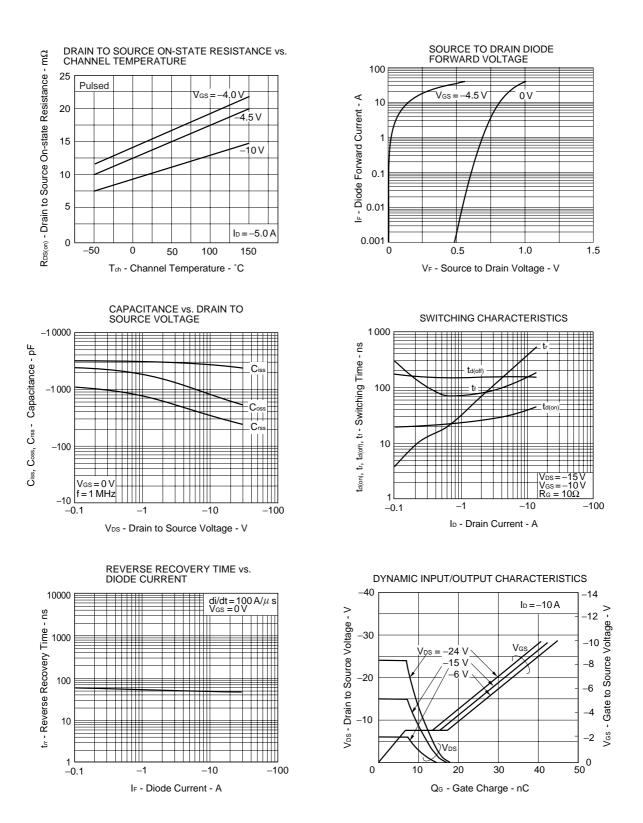


GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



Data Sheet G14285EJ1V0DS00

μ**ΡΑ1731** 



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